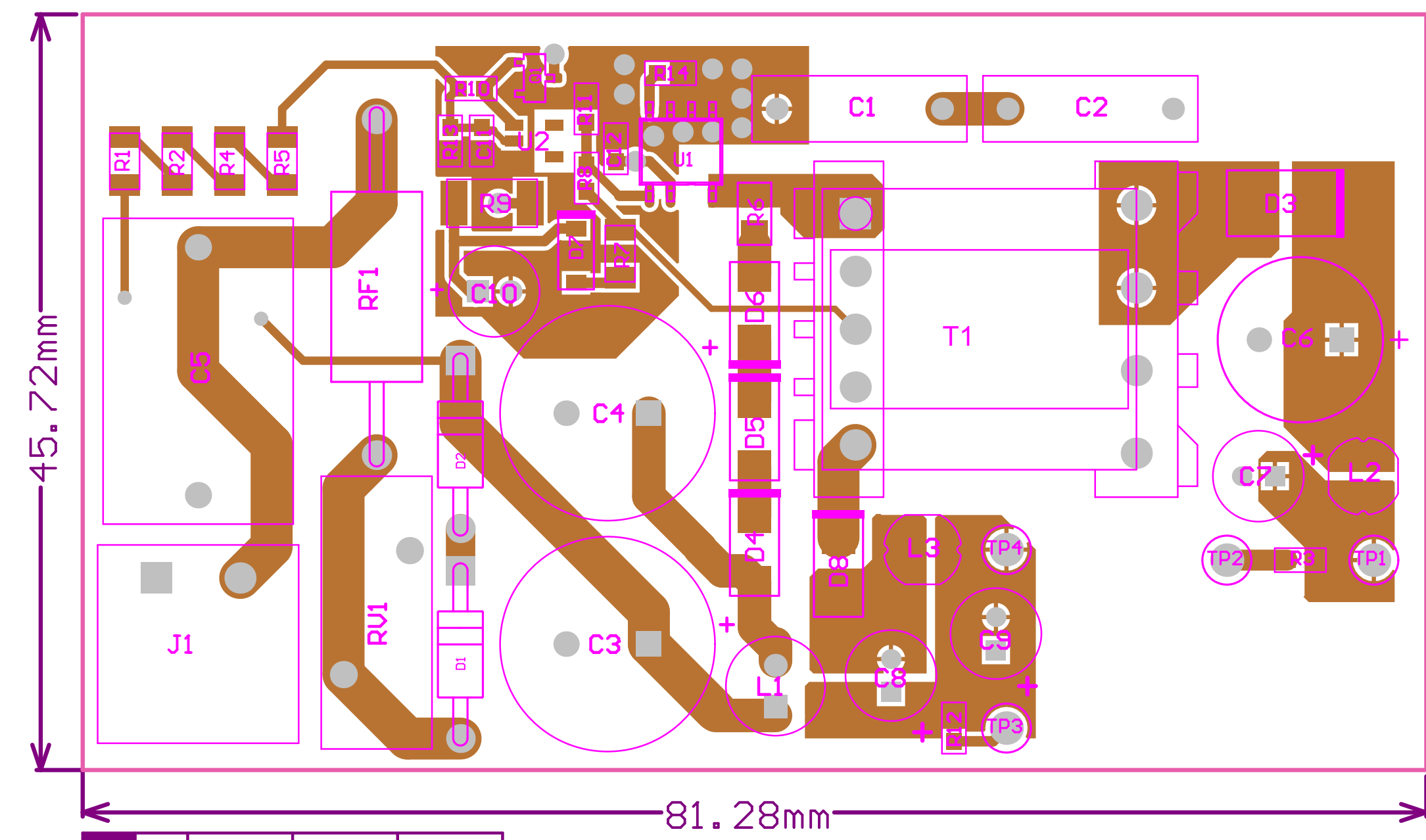


The reference design PMP30070 Rev_C has been built on PMP30070 Rev_A Board



PCB VIEWED FROM TOP SIDE

Top Layer

M2 Board Dimensions

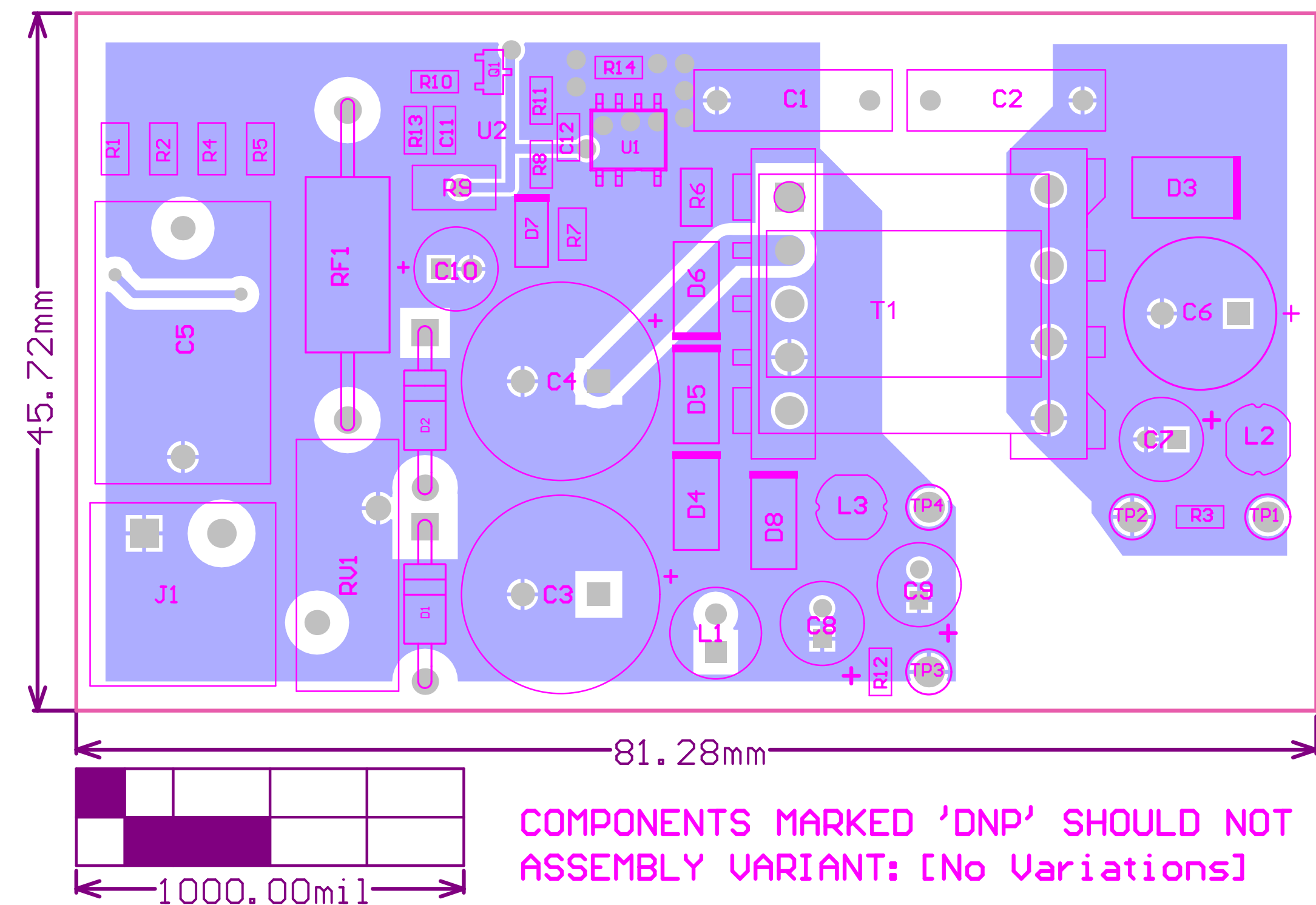
M1 Board Outline

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]



PROJECT TITLE: 90-350VAC to 12V and -10V 8.5W Isolated Flyback	
DESIGNED FOR: Public Release	
FILE NAME: PMP30070 Rev_A PCB.PcbDoc	
ENGINEER: R. Scibilia	LAYOUT BY: R. Scibilia
SCALE: 1.00	ALTIUM DESIGNER VERSION: 16.0.9.368

M9 Title Sheet	BOARD #: PMP30070	REV: A	SUN REV: Not In VersionControl	Texas Instruments (TI) and/or its licensors do not warrant the accuracy or completeness of this specification or any information contained therein. TI and/or its licensors do not warrant that this design will meet the specifications, will be suitable for your application or fit for any particular purpose, or will operate in an implementation. TI and/or its licensors do not warrant that the design is production worthy. You should completely validate and test your design implementation to confirm the system functionality for your application.	
PLOT NAME = Multilayer Composite Print	GENERATED : 10/13/2016 11:24:02 AM	TEXAS INSTRUMENTS		SCALE: 1.00	ALTIUM DESIGNER VERSION: 16.0.9.368



PCB VIEWED FROM TOP SIDE

- Bottom Layer
- M2 Board Dimensions
- M1 Board Outline

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: [No Variations]



PROJECT TITLE: 90-350VAC to 12V and -10V 8.5W Isolated Flyback	
DESIGNED FOR: Public Release	
FILE NAME: PMP30070_Rev_A_PCB.PcbDoc	
ENGINEER: R. Scibilia	LAYOUT BY: R. Scibilia
SCALE: 1.00	ALTIUM DESIGNER VERSION: 16.0.9.368

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PLOT NAME = Multilayer Composite Print	GENERATED : 10/13/2016 11:24:03 AM	TEXAS INSTRUMENTS		SCALE: 1.00	ALTIUM DESIGNER VERSION: 16.0.9.368

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